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2	18	((skin adj effect) and (model or simulat\$4)) and (s adj2 parameter)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/09/06 08:43
3	1		USPAT	2004/09/06 08:39
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	4	(dielectric adj2 loss\$2) same (transmision adj2 line)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/09/05 10:40
	0	(dielectric adj2 loss\$2) same (transmision adj2 line)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/09/05 10:40
	9	dielectric adj2 loss\$2	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/09/05 10:44
	3386	(IC adj2 chip) and ((signal adj2 degradation) or (dielectric) or (transmission adj2 loss\$2))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/09/05 10:46
	15	((IC adj2 chip) and ((signal adj2 degradation) or (dielectric) or (transmission adj2 loss\$2))) and spice	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/09/06 08:27



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1 Breaking the ice [transmission line icing]

Sullivan, C.R.; Petrenko, V.F.; McCurdy, J.D.; Kozliouk, V.;

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16 Analysis of lossy multi-chip module interconnections using finite element method

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